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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









General Description

The MAX1533A/MAX1537A are dual step-down, switchmode power-supply (SMPS) controllers with synchronous rectification, intended for main 5V/3.3V power generation in battery-powered systems. Fixed-frequency operation with optimal interleaving minimizes input ripple current from the lowest input voltages up to the 26V maximum input. Optimal 40/60 interleaving allows the input voltage to go down to 8.3V before duty-cycle overlap occurs, compared to 180° out-of-phase regulators where the duty-cycle overlap occurs when the input drops below 10V. Output current sensing provides accurate current limit using a sense resistor. Alternatively, power dissipation can be reduced using lossless inductor current sensing.

Internal 5V and 3.3V linear regulators power the MAX1533A/MAX1537A and their gate drivers, as well as external keep-alive loads, up to a total of 100mA. When the main PWM regulators are in regulation, automatic bootstrap switches bypass the internal linear regulators, providing currents up to 200mA from each linear output. An additional 5V to 23V adjustable internal 150mA linear regulator is typically used with a secondary winding to provide a 12V supply.

The MAX1533A/MAX1537A include on-board power-up sequencing, a power-good (PGOOD) output, digital soft-start, and internal soft-shutdown output discharge that prevents negative voltages on shutdown. The MAX1533A is available in a 32-pin 5mm x 5mm thin QFN package, and the MAX1537A is available in a 36pin 6mm x 6mm thin QFN package. The exposed backside pad improves thermal characteristics for demanding linear keep-alive applications.

Applications

2 to 4 Li+ Cells Battery-Powered Devices Notebook and Subnotebook Computers PDAs and Mobile Communicators

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX1533AETJ	-40°C to +85°C	32 Thin QFN 5mm x 5mm
MAX1533AETJ+	-40°C to +85°C	32 Thin QFN 5mm x 5mm
MAX1537AETX	-40°C to +85°C	36 Thin QFN 6mm x 6mm
MAX1537AETX+	-40°C to +85°C	36 Thin QFN 6mm x 6mm

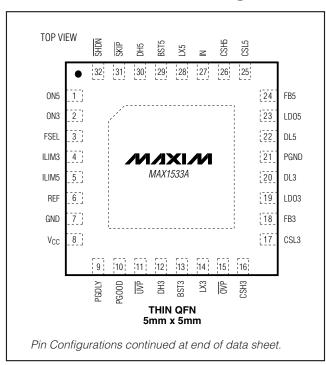
⁺Denotes lead-free package.

Dual Mode is a trademark of Maxim Integrated Products, Inc.

Features

- ♦ Fixed-Frequency, Current-Mode Control
- ♦ 40/60 Optimal Interleaving
- **♦** Accurate Differential Current-Sense Inputs
- ♦ Internal 5V and 3.3V Linear Regulators with 100mA Load Capability
- ♦ Auxiliary 12V or Adjustable 150mA Linear Regulator (MAX1537A Only)
- ♦ Dual Mode™ Feedback—3.3V/5V Fixed or Adjustable Output (Dual Mode) Voltages
- ♦ 200kHz/300kHz/500kHz Switching Frequency
- ♦ Versatile Power-Up Sequencing
- ◆ Adjustable Overvoltage and Undervoltage **Protection**
- ♦ 6V to 26V Input Range
- ♦ 2V ±0.75% Reference Output
- ♦ Power-Good Output
- ♦ Soft-Shutdown
- ♦ 5µA (typ) Shutdown Current

Pin Configurations



ABSOLUTE MAXIMUM RATINGS

IN, SHDN, INA, LDOA to GND	
GND to PGND	0.3V to +0.3V
LDO5, LDO3, V _{CC} to GND	0.3V to +6V
ILIM3, ILIM5, PGDLY to GND	
CSL3, CSH3, CSL5, CSH5 to GND	0.3V to +6V
ON3, ON5, FB3, FB5 to GND	0.3V to +6V
SKIP, OVP, UVP to GND	0.3V to +6V
PGOOD, FSEL, ADJA, ONA to GND.	0.3V to +6V
REF to GND	0.3V to $(V_{CC} + 0.3V)$
DL3, DL5 to PGND	0.3V to $(V_{LDO5} + 0.3V)$
BST3, BST5 to PGND	0.3V to +36V
LX3 to BST3	6V to +0.3V
DH3 to LX3	0.3V to $(V_{BST3} + 0.3V)$

LX5 to BST5	6V to +0.3V
DH5 to LX5	$0.3V$ to $(V_{BST5} + 0.3V)$
LDO3, LDO5 Short Circuit to GND	Momentary
REF Short Circuit to GND	Momentary
INA Shunt Current	+15mA
Continuous Power Dissipation ($T_A = +70$	O°C)
32-Pin TQFN (derate 21.3mW/°C abo	ve +70°C)1702mW
36-Pin TQFN (derate 26.3mW/°C abo	
Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(Circuit of Figure 1, $V_{IN} = 12V$, both SMPS enabled, $V_{CC} = 5V$, FSEL = REF, $\overline{SKIP} = GND$, $V_{ILIM} = V_{LDO5}$, $V_{INA} = 15V$, $V_{LDOA} = 12V$, $V_{LDO5} = V_{LDO5} = V_{L$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
INPUT SUPPLIES (Note 1)						
V _{IN} Input Voltage Range	VIN	LDO5 in regulation	6		26	\ \
VIN Input voltage hange	VIN	IN = LDO5, V _{OUT5} < 4.43V	4.5		5.5	V
V _{IN} Operating Supply Current	I _{IN}	LDO5 switched over to CSL5		15	35	μΑ
V _{IN} Standby Supply Current	I _{IN(STBY)}	V _{IN} = 6V to 26V, both SMPS off, includes ISHDN		100	170	μΑ
V _{IN} Shutdown Supply Current	IN(SHDN)	V _{IN} = 6V to 26V, SHDN = GND		5	17	μΑ
Quiescent Power Consumption	PQ	Both SMPS on, FB3 = FB5 = SKIP = GND, VCSL3 = 3.5V, VCSL5 = 5.3V, VINA = 15V, ILDOA = 0, PIN + PCSL3 + PCSL5 + PINA		3.5	4.5	mW
V _{CC} Quiescent Supply Current	Icc	Both SMPS on, FB3 = FB5 = GND, V _{CSL3} = 3.5V, V _{CSL5} = 5.3V		1.1	2.1	mA
MAIN SMPS CONTROLLERS						
3.3V Output Voltage in Fixed Mode	V _{OUT3}	$V_{IN} = 6V$ to 26V, $\overline{SKIP} = V_{CC}$ (Note 2)	3.280	3.33	3.380	V
5V Output Voltage in Fixed Mode	V _{OUT5}	V _{IN} = 6V to 26V, SKIP = V _{CC} (Note 2)	4.975	5.05	5.125	V
Feedback Voltage in Adjustable Mode	V _{FB} _	V _{IN} = 6V to 26V, FB3 or FB5, duty factor = 20% to 80% (Note 2)	0.990	1.005	1.020	V
Output-Voltage Adjust Range		Either SMPS	1.0		5.5	V
FB3, FB5 Dual-Mode Threshold			0.1		0.2	V
Feedback Input Leakage Current		V _{FB3} = V _{FB5} = 1.1V	-0.1		+0.1	μΑ
DC Load Regulation		Either SMPS, SKIP = V _{CC} , I _{LOAD} = 0 to full load		-0.1		%

ELECTRICAL CHARACTERISTICS (continued)

(Circuit of Figure 1, V_{IN} = 12V, both SMPS enabled, V_{CC} = 5V, FSEL = REF, \overline{SKIP} = GND, V_{ILIM} = V_{LDO5} , V_{INA} = 15V, V_{LDOA} = 12V, V_{LDO5} = V_{LDO5} = V_{LDO5} = V_{LDO5} = V_{LDO5} = 12V, V_{LDO5} = 1

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Line-Regulation Error		Either SMPS, duty	cycle = 10% to 90%		1		%
		FSEL = GND	FSEL = GND		200	230	
Operating Frequency (Note 1)	fosc	FSEL = REF		270	300	330	kHz
		FSEL = V _{CC}		425	500	575	
		FSEL = GND		91	93		
Maximum Duty Factor (Note 1)	D _{MAX}	FSEL = REF		91	93		%
		FSEL = V _{CC}		91	93		
Minimum On-Time	ton(MIN)	(Note 3)				200	ns
SMPS3 to SMPS5 Phase Shift		SMPS5 starts afte	r SMPS3		40		%
OWN GO TO GIVIN GO T FIELDE GITINE		Olvii 00 Starts arte	1 OIVII OO		144		Deg
CURRENT LIMIT							
ILIM_ Adjustment Range				0.5		V_{REF}	V
Current-Sense Input Range		CSH_, CSL_		0		5.5	V
Current-Sense Input Leakage Current		CSH_, V _{CSH} _ = 5	.5V	-1		+1	μΑ
Current-Limit Threshold (Fixed)	V _{LIMIT} _	V _{CSH} V _{CSL} _, IL	IM_ = V _{CC}	70	75	80	mV
			V _{ILIM} _ = 2.00V	170	200	230	
Current-Limit Threshold (Adjustable)	V _{LIMIT} _	VCSH VCSL_	V _{ILIM} _ = 1.00V	91	100	109	mV
			$V_{ILIM} = 0.50V$	42	50	58	
Current-Limit Threshold (Negative)	V _{NEG}	V _{CSH} - V _{CSL} , Sh current limit	$\overline{\text{KIP}} = V_{CC}$, percent of		-120		%
Current-Limit Threshold (Zero Crossing)	V _Z X	V _{PGND} - V _{LX} , SK	IP = GND, ILIM_ = V _{CC}		3		mV
			ILIM_ = VCC	10	16	22	mV
Idle Mode™ Threshold	VIDLE	VCSH VCSL_	With respect to current-limit threshold (V _{LIMIT})		20		%
ILIM_ Leakage Current		ILIM3 = ILIM5 = C	GND or V _{CC}	-0.1		+0.1	μΑ
Soft-Start Ramp Time	tss	Measured from th	e rising edge of ON_ to		512/ fosc		S
INTERNAL FIXED LINEAR REGUL	ATORS	•					
LDO5 Output Voltage	V _{LDO5}	ON3 = ON5 = GND, 6V < V _{IN} < 26V, 0 < I _{LDO5} < 100mA		4.80	4.95	5.10	V
LDO5 Undervoltage-Lockout Fault Threshold		Rising edge, hysteresis = 1%		3.75	4.0	4.25	V
LDO5 Bootstrap Switch Threshold		Rising edge of CS	SL5, hysteresis = 1%	4.41		4.75	V
LDO5 Bootstrap Switch Resistance		LDO5 to CSL5, V ₀ I _{LDO5} = 50mA	CSL5 = 5V,		0.75	3	Ω

Idle Mode is a trademark of Maxim Integrated Products, Inc.

ELECTRICAL CHARACTERISTICS (continued)

(Circuit of Figure 1, V_{IN} = 12V, both SMPS enabled, V_{CC} = 5V, FSEL = REF, \overline{SKIP} = GND, V_{ILIM} = V_{LDO5} , V_{INA} = 15V, V_{LDOA} = 12V, V_{LDO5} = V_{LDO5} = V_{LDO5} = V_{LDO5} = V_{LDO5} = 12V, V_{LDO5} = 1

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
LDO3 Output Voltage	V _{LDO3}	Standby mode, 6V < V _{IN} < 26V, 0 < I _{LOAD} < 100mA	3.20	3.35	3.42	V
LDO3 Bootstrap Switch Threshold		Rising edge of CSL3, hysteresis = 1%	2.83		3.10	V
LDO3 Bootstrap Switch Resistance		LDO3 to CSL3, V _{CSL3} = 3.2V, I _{LDO3} = 50mA		1	3	Ω
Short-Circuit Current		LDO3 = LDO5 = GND, CSL3 = CSL5 = GND		150	220	mA
Short-Circuit Current (Switched Over to CSL_)		LDO3 = LDO5 = GND, V _{CSL3} > 3.1V, V _{CSL5} > 4.7V	250			mA
AUXILIARY LINEAR REGULATOR	R (MAX1537A	ONLY)	•			
LDOA Voltage Range	V _{LDOA}		5		23	V
INA Voltage Range	VINA		6		24	V
LDOA Regulation Threshold, Internal Feedback		ADJA = GND, 0 < I _{LDOA} < 120mA, V _{INA} > 13V	11.4	12.0	12.4	V
ADJA Regulation Threshold, External Feedback	V _{ADJA}	0 < I _{LDOA} < 120mA, V _{LDOA} > 5.0V and V _{INA} > V _{LDOA} + 1V	1.94	2.00	2.06	V
ADJA Dual-Mode Threshold			0.1	0.15	0.2	V
ADJA Leakage Current		V _{ADJA} = 2.1V	-0.1		+0.1	μΑ
LDOA Current Limit		V _{LDOA} forced to V _{INA} - 1V, V _{ADJA} = 1.9V, V _{INA} > 6V	150			mA
Secondary Feedback Regulation Threshold		VINA - VLDOA	0.65	0.8	0.95	V
DL Duty Factor		V _{INA} - V _{LDOA} < 0.7V, pulse width with respect to switching period		33		%
INA Quiescent Current	I _{INA}	V _{INA} = 24V, I _{LDOA} = no load		50	165	μΑ
INA Shunt Sink Current		V _{INA} = 28V	10			mA
INA Leakage Current	INA(SHDN)	V _{INA} = 5V, LDOA disabled			30	μΑ
REFERENCE (REF)						
Reference Voltage	V _{REF}	$V_{CC} = 4.5V \text{ to } 5.5V, I_{REF} = 0$	1.985	2.00	2.015	V
Reference Load Regulation		$I_{REF} = -10\mu A \text{ to } +100\mu A$	1.980		2.020	V
REF Lockout Voltage	V _{REF} (UVLO)	Rising edge, hysteresis = 350mV		1.95		V
FAULT DETECTION						
Output Overvoltage Trip Threshold		OVP = GND, with respect to error- comparator threshold	8	11	15	%
Output Overvoltage Fault- Propagation Delay	tovp	50mV overdrive		10		μs

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ELECTRICAL CHARACTERISTICS (continued)

(Circuit of Figure 1, V_{IN} = 12V, both SMPS enabled, V_{CC} = 5V, FSEL = REF, \overline{SKIP} = GND, V_{ILIM} = V_{LDO5} , V_{INA} = 15V, V_{LDOA} = 12V, V_{LDO5} = V_{LDO5} = V_{LDO5} = V_{LDO5} = V_{LDO5} = 1000 and V_{LDO5} = 12V, V_{LDO5} = 1000 and V_{LDO5}

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Output Undervoltage-Protection Trip Threshold		With respect to error-compara	ator threshold	65	70	75	%
Output Undervoltage Fault- Propagation Delay	tuvp	50mV overdrive			10		μs
Output Undervoltage-Protection Blanking Time	tBLANK	From rising edge of ON_			6144/ fosc		S
PGOOD Lower Trip Threshold		With respect to error-compara threshold, hysteresis = 1%	ator	-14	-10	-7.5	%
PGOOD Propagation Delay	tpgood_	Falling edge, 50mV overdrive			10		μs
PGOOD Output Low Voltage		I _{SINK} = 4mA				0.4	V
PGOOD Leakage Current	IPGOOD_	High state, PGOOD forced to	5.5V			1	μΑ
PGDLY Pullup Current		PGDLY = GND		4	5	6	μΑ
PGDLY Pulldown Resistance					10	25	Ω
PGDLY Trip Threshold				REF- 0.2	REF	REF+ 0.2	V
Thermal-Shutdown Threshold	TSHDN	Hysteresis = 15°C			+160		°C
GATE DRIVERS							
DH_ Gate-Driver On-Resistance	R _{DH}	BST LX_ forced to 5V			1.5	5	Ω
		DL_, high state		1.7	5	0	
DL_ Gate-Driver On-Resistance	R _{DL}	DL_, low state			0.6	3	Ω
DH_ Gate-Driver Source/Sink Current	lDH	DH_ forced to 2.5V, BST LX_ forced to 5V			2		А
DL_ Gate-Driver Source Current	I _{DL}	DL_ forced to 2.5V			1.7		А
DL_ Gate-Driver Sink Current	IDL (SINK)	DL_ forced to 2.5V			3.3		Α
		DL_ rising			35		
Dead Time	tDEAD	DH_ rising			26		ns
LX_, BST_ Leakage Current		V _{BST} _ = V _L X_ = 26V			<2	20	μA
INPUTS AND OUTPUTS	•			ı			
			High	2.4			
Logic Input Voltage		SKIP, hysteresis = 600mV	Low			0.8	V
Fault Enable Logic Input Voltage		OVP, UVP, ONA	High	0.7 x V _C C			V
			Low			0.4	
Logic Input Current		OVP, UVP, SKIP, ONA		-1		+1	μΑ
CUDN logget Trip 11		Rising trip level		1.10	1.6	2.20	17
SHDN Input Trip Level		Falling trip level		0.96	1	1.04	V
	1		.1			0.0	
		Clear fault level/SMPS off leve	91			0.8	
ON_ Input Voltage		Clear fault level/SMPS off level Delay start level (REF)	91	1.9		2.1	V

ELECTRICAL CHARACTERISTICS (continued)

(Circuit of Figure 1, V_{IN} = 12V, both SMPS enabled, V_{CC} = 5V, FSEL = REF, \overline{SKIP} = GND, V_{ILIM} = V_{LDO5} , V_{INA} = 15V, V_{LDOA} = 12V, V_{LDOA} =

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
		High	V _C C - 0.2			
FSEL Three-Level Input Logic		REF	1.7		2.3	V
		GND			0.4]
Janut Laglage Current		OVP, UVP, SKIP, ONA, ON3, ON5 = GND or VCC	-1		+1	
Input Leakage Current		SHDN, 0V or 26V	-1		+1	μA
		FSEL = GND or V _{CC}	-3		+3	
CSL_ Discharge-Mode On-Resistance	RDISCHARGE			10	25	Ω
CSL_ Synchronous-Rectifier Discharge-Mode Turn-On Level			0.2	0.3	0.4	V

ELECTRICAL CHARACTERISTICS

(Circuit of Figure 1, V_{IN} = 12V, both SMPS enabled, V_{CC} = 5V, FSEL = REF, \overline{SKIP} = GND, V_{ILIM} = V_{LDO5} , V_{INA} = 15V, V_{LDOA} = 12V, V_{LDO5} = V_{LDO5} = V_{LDO5} = V_{LDO5} = V_{LDO5} = 1000 = 1000, V_{INA} = 15V, V_{LDOA} = 12V, V_{LDO5} = 1000 = 1000, V_{INA} = 15V, V_{LDOA} = 12V, V_{LDO5} = 1000 = 1000, V_{INA} = 15V, V_{LDOA} = 12V, V_{LDO5} = 1000 = 1000, V_{INA} = 15V, V_{LDO5} = 12V, V_{LDO5} = 1000 = 1000, V_{INA} = 15V, V_{LDO5} = 12V, V_{LDO5} = 1000 = 1000, V_{INA} = 15V, V_{LDO5} = 12V, V_{LDO5} = 1000 = 1000, V_{INA} = 15V, V_{LDO5} = 12V, V_{LDO5} = 1000 = 1000, V_{INA} = 15V, V_{LDO5} = 12V, V_{LDO5} = 1000 = 1000, V_{INA} = 15V, V_{LDO5} = 12V, V_{LDO5} = 1000 = 1000, V_{INA} = 15V, V_{LDO5} = 12V, V_{LDO5} = 1000 = 1000, V_{INA} = 15V, V_{LDO5} = 12V, V_{LDO5} = 1000 = 1000, V_{INA} = 15V, V_{LDO5} = 12V, V_{LDO5} = 1000 = 1000, V_{INA} = 15V, V_{LDO5} = 1000 = 1000, V_{LDO5} = 1

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS
INPUT SUPPLIES (Note 1)					
V _{IN} Input Voltage Range	VIN	LDO5 in regulation	6	26	V
VIN Input voitage hange	VIN	IN = LDO5, V _{OUT5} < 4.4V	4.5	5.5	V
V _{IN} Operating Supply Current	I _{IN}	LDO5 switched over to CSL5, either SMPS on		35	μΑ
V _{IN} Standby Supply Current	I _{IN} (STBY)	V _{IN} = 6V to 26V, both SMPS off, includes I _{SHDN}		170	μΑ
V _{IN} Shutdown Supply Current	IN(SHDN)	V _{IN} = 6V to 26V		17	μΑ
Quiescent Power Consumption	PQ	Both SMPS on, FB3 = FB5 = SKIP = GND, VCSL3 = 3.5V, VCSL5 = 5.3V, VINA = 15V, ILDOA = 0, PIN + PCSL3 + PCSL5 + PINA		4.5	mW
V _{CC} Quiescent Supply Current	Icc	Both SMPS on, FB3 = FB5 = GND, V _{CSL3} = 3.5V, V _{CSL5} = 5.3V		2.5	mA
MAIN SMPS CONTROLLERS					
3.3V Output Voltage in Fixed Mode	V _О ТЗ	V _{IN} = 6V to 26V, $\overline{\text{SKIP}}$ = V _{CC} (Note 2)	3.28	3.38	V
5V Output Voltage in Fixed Mode	V _{OUT5}	$V_{IN} = 6V$ to 26V, $\overline{SKIP} = V_{CC}$ (Note 2)	4.975	5.125	V
Feedback Voltage in Adjustable Mode	V _{FB3} , V _{FB5}	V _{IN} = 6V to 26V, FB3 or FB5, duty factor = 20% to 80% (Note 2)	0.982	1.018	V
Output-Voltage Adjust Range		Either SMPS	1.0	5.5	V
FB3, FB5 Adjustable-Mode Threshold Voltage		Dual-mode comparator	0.1	0.2	V

ELECTRICAL CHARACTERISTICS (continued)

(Circuit of Figure 1, V_{IN} = 12V, both SMPS enabled, V_{CC} = 5V, FSEL = REF, \overline{SKIP} = GND, V_{ILIM} = V_{LDO5} , V_{INA} = 15V, V_{LDOA} = 12V, V_{LDO5} = V_{LDO5} =

PARAMETER	SYMBOL	co	ONDITIONS	MIN	MAX	UNITS
		FSEL = GND		170	230	
Operating Frequency (Note 1)	fosc	FSEL = REF	FSEL = REF		330	kHz
		FSEL = V _{CC}		375	575	
		FSEL = GND		91		
Maximum Duty Factor (Note 1)	D _{MAX}	FSEL = REF		91		%
		FSEL = V _{CC}		91		
Minimum On-Time	ton(MIN)				250	ns
CURRENT LIMIT						
ILIM_ Adjustment Range				0.5	V _{REF}	V
Current-Limit Threshold (Fixed)	V _{LIMIT} _	V _{CSH} V _{CSL} _, IL	IM_ = VCC	67	83	mV
			V _{ILIM} _ = 2.00V	170	230	
Current-Limit Threshold (Adjustable)	V _{LIMIT} _	V _{CSH} V _{CSL} _	V _{ILIM} _ = 1.00V	90	110	mV
(Adjustable)			V _{ILIM} _ = 0.50V	40	60	
INTERNAL FIXED LINEAR REGU	JLATORS					
LDO5 Output Voltage	V _{LDO5}		ON3 = ON5 = GND, 6V < V _{IN} < 26V, 0 < I _{LDO5} < 100mA		5.1	V
LDO5 Undervoltage-Lockout Fault Threshold		Rising edge, hyste	eresis = 1%	3.75	4.30	V
LDO3 Output Voltage	V _{LDO3}	Standby mode, 6\ 0 < I _{LOAD} < 100m		3.20	3.43	V
AUXILIARY LINEAR REGULATO	R (MAX1537)	A ONLY)				I.
LDOA Voltage Range	V _{LODA}			5	23	V
INA Voltage Range	VINA			6	24	V
LDOA Regulation Threshold, Internal Feedback		ADJA = GND, 0 < V _{INA} > 13V	I _{LDOA} < 120mA,	11.40	12.55	V
ADJA Regulation Threshold, External Feedback	Vadja	0 < I _{LDOA} < 120mA, V _{LDOA} > 5.0V and V _{INA} > V _{LDOA} + 1V		1.94	2.08	V
ADJA Dual-Mode Threshold		ADJA	ADJA		0.25	V
Secondary Feedback Regulation Threshold		VINA - VLDOA		0.63	0.97	V
INA Quiescent Current	I _{INA}	V _{INA} = 24V, I _{LDOA} = no load			165	μΑ
REFERENCE (REF)						
Reference Voltage	V _{REF}	$V_{CC} = 4.5V \text{ to } 5.5$	V, I _{REF} = 0	1.97	2.03	V
		7.112				·

ELECTRICAL CHARACTERISTICS (continued)

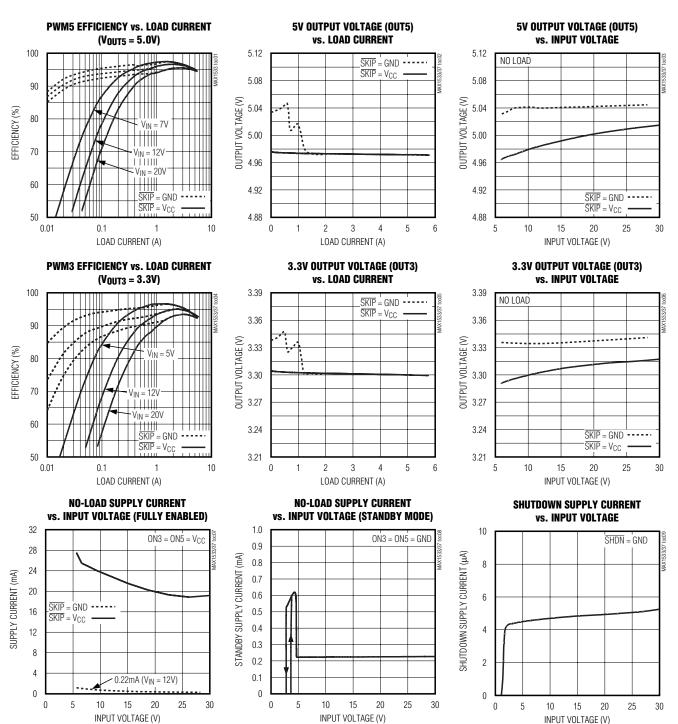
(Circuit of Figure 1, V_{IN} = 12V, both SMPS enabled, V_{CC} = 5V, FSEL = REF, \overline{SKIP} = GND, V_{ILIM} = V_{LDO5} , V_{INA} = 15V, V_{LDOA} = 12V, V_{LDO5} = V_{LDO5} = 15V, V_{LDO5} = 12V, V_{LDO5} = 12V,

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS	
FAULT DETECTION						
Output Overvoltage Trip Threshold		OVP = GND, with respect to comparator threshold	error-	+8	+15	%
Output Undervoltage-Protection Trip Threshold		With respect to error-compa	rator threshold	+65	+75	%
PGOOD Lower Trip Threshold		With respect to error-compa hysteresis = 1%	rator threshold,	-14.0	-7.0	%
PGOOD Output Low Voltage		I _{SINK} = 4mA			0.4	V
PGDLY Pulldown Resistance					25	Ω
PGDLY Trip Threshold				REF- 0.2	REF+ 0.2	V
GATE DRIVERS	1.			•		•
DH_ Gate-Driver On-Resistance	R _{DH}	BST LX_ forced to 5V			5	Ω
DL_ Gate-Driver On-Resistance	D _D ,	DL_, high state			5	Ω
DL_ Gate-Driver On-nesistance	R _{DL}	DL_, low state			3	52
INPUTS AND OUTPUTS						
Logic Input Voltage	ļ	SKIP, hysteresis = 600mV	High	2.4		V
Logic input voltage		Orth, mysteresis = dooniv	Low		8.0	v
Fault Enable Logic Input Voltage		OVP, UVP, ONA	High	0.7 x VCC		V
			Low		0.4	
SHDN Input Trip Level		Rising trip level		1.1	2.2	V
Show input trip Level		Falling trip level		0.95	1.05	V
		Clear fault level			0.8	
ON_ Input Voltage		SMPS off level			1.6	V
ON_INPUT VOITage		Delay start level (REF)		1.9	2.1	<u> </u>
		SMPS on level		2.4		
		High		V _{CC} - 0.2		
FSEL Three-Level Input Logic		REF		1.7	2.3	V
		GND			0.4	

- Note 1: The MAX1533A/MAX1537A cannot operate over all combinations of frequency, input voltage (V_{IN}), and output voltage. For large input-to-output differentials and high-switching frequency settings, the required on-time may be too short to maintain the regulation specifications. Under these conditions, a lower operating frequency must be selected. The minimum on-time must be greater than 150ns, regardless of the selected switching frequency. On-time and off-time specifications are measured from 50% point to 50% point at the DH_ pin with LX_ = GND, VBST_ = 5V, and a 250pF capacitor connected from DH_ to LX_. Actual in-circuit times may differ due to MOSFET switching speeds.
- Note 2: When the inductor is in continuous conduction, the output voltage has a DC regulation level lower than the error-comparator threshold by 50% of the ripple. In discontinuous conduction (SKIP = GND, light load), the output voltage has a DC regulation level higher than the trip level by approximately 1% due to slope compensation.
- Note 3: Specifications are guaranteed by design, not production tested.
- Note 4: Specifications to -40°C are guaranteed by design, not production tested.

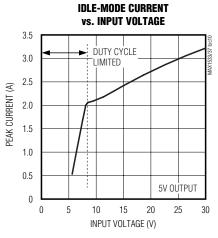
Typical Operating Characteristics

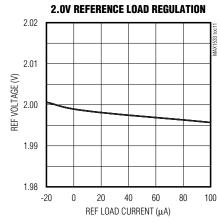
(MAX1537A circuit of Figure 1, V_{IN} = 12V, LDO5 = V_{CC} = 5V, SKIP = GND, FSEL = REF, T_A = +25°C, unless otherwise noted.)

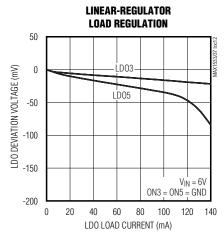


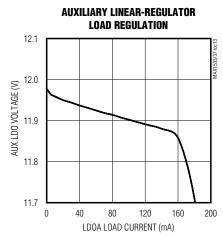
Typical Operating Characteristics (continued)

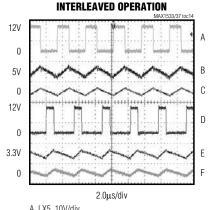
(MAX1537A circuit of Figure 1, V_{IN} = 12V, LDO5 = V_{CC} = 5V, SKIP = GND, FSEL = REF, T_A = +25°C, unless otherwise noted.)





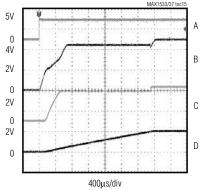






- A. LX5, 10V/div
- B. 5V OUTPUT, 100mV/div
- C. PWM5 INDUCTOR CURRENT, 5A/div
- D. LX3, 10V/div
- E. 3.3V OUTPUT, 100mV/div
- F. PWM3 INDUCTOR CURRENT, 5A/div

LINEAR-REGULATOR STARTUP WAVEFORMS



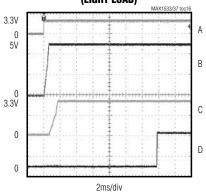
- A. SHDN, 5V/div
- B. LD05, 2V/div
- C. LD03, 2V/div
- D. REF, 2V/div
- 100Ω LOAD ON LD05 AND LD03

Typical Operating Characteristics (continued)

2V

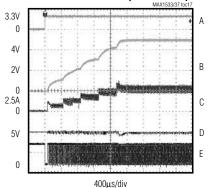
(MAX1537A circuit of Figure 1, V_{IN} = 12V, LDO5 = V_{CC} = 5V, SKIP = GND, FSEL = REF, T_A = +25°C, unless otherwise noted.)

DELAYED STARTUP WAVEFORM (LIGHT LOAD)



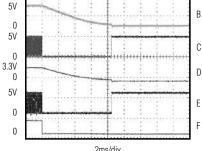
- A. ON5, 5V/div B. 5V OUTPUT, 2V/div
- C. 3.3V OUPUT, 2V/div
- D PGOOD 2V/div
- 100Ω LOAD ON OUT5 AND OUT3, ON3 = REF

STARTUP WAVEFORM (HEAVY LOAD)



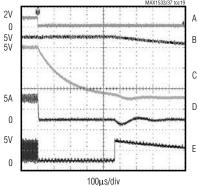
- A. ON5. 5V/div
- B. 5V OUTPUT, 2V/div
- C. INDUCTOR CURRENT, 5A/div
- D. LD05, 1V/div
- E. DL5. 5V/div
- 1.0Ω LOAD

SHUTDOWN WAVEFORM (NO LOAD)



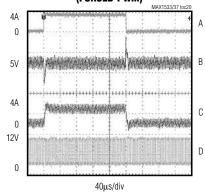
- A. SHDN, 5V/div B. 5V OUTPUT, 5V/div C. DL5. 5V/div
- D. 3.3V OUTPUT, 5V/div E. DL3, 5V/div
- F. PGOOD, 5V/div $\text{ON3} = \text{ON5} = \text{V}_{\text{CC}}, \, \overline{\text{OVP}} = \text{GND}$

SHUTDOWN WAVEFORM (1 Ω LOAD)



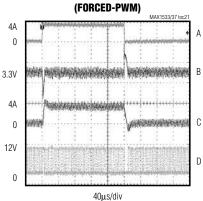
- A. SHDN, 5V/div
- B. LD05. 2V/div
- C. 5V OUTPUT, 2V/div
- D. INDUCTOR CURRENT, 5A/div
- E. DL5, 5V/div
- $ON3 = ON5 = V_{CC}, \overline{OVP} = GND$

5V OUTPUT LOAD TRANSIENT (FORCED-PWM)



- A. I_{OUT5} = 0.2A TO 4A, 5A/div
- B. V_{OUT5} = 5.0V, 100mV/div
- C. INDUCTOR CURRENT, 5A/div
- D. LX5, 10V/div
- $\overline{SKIP} = V_{CC}$

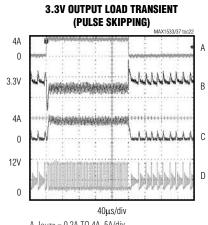
3.3V OUTPUT LOAD TRANSIENT



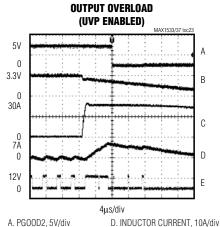
- A. I_{OUT3} = 0.2A TO 4A, 5A/div B. $V_{OUT3} = 3.3V$, 100 mV/div
- C. INDUCTOR CURRENT, 5A/div
- D. LX3, 10V/div
- SKIP = Vcc

Typical Operating Characteristics (continued)

(MAX1537A circuit of Figure 1, V_{IN} = 12V, LDO5 = V_{CC} = 5V, \overline{SKIP} = GND, FSEL = REF, T_A = +25°C, unless otherwise noted.)

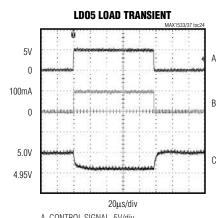


A. I_{OUT3} = 0.2A TO 4A, 5A/div B. $V_{OUT3} = 3.3V$, 100 mV/divC. INDUCTOR CURRENT, 5A/div D. LX3, 10V/div $\overline{SKIP} = GND$



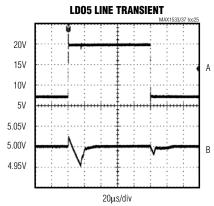
E. LX3, 20V/div

B. 3.3V OUTPUT, 3.3V/div C. LOAD (0 TO 30A), 20A/div



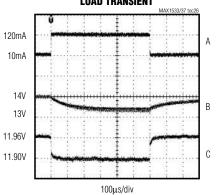
В

A. CONTROL SIGNAL, 5V/div B. I_{LD05} = 1mA TO 100mA, 100mA/div C. LD05, 50m/div ON3 = ON5 = GND



A. INPUT VOLTAGE ($V_{IN} = 7V \text{ TO } 20V$), 5V/divB. LD05 OUTPUT VOLTAGE, 50mV/div $0N3 = 0N5 = GND, I_{LD05} = 20mA$

AUXILIARY LINEAR-REGULATOR LOAD TRANSIENT



A. I_{LDOA} = 10mA TO 100mA, 100mA/div B. INA. 1V/div C. LDOA, 50mV/div INA = VOLTAGE GENERATED BY SECONDARY TRANSFORMER WINDING

Pin Description

PIN			
MAX1533A	MAX1537A	NAME	FUNCTION
_	1	ADJA	Auxiliary Feedback Input. Connect a resistive voltage-divider from LDOA to analog ground to adjust the auxiliary linear-regulator output voltage. ADJA regulates at 2V. Connect ADJA to GND for nominal 12V output using internal feedback.
1	2	ON5	5V SMPS Enable Input. The 5V SMPS is enabled if ON5 is greater than the SMPS on level and disabled if ON5 is less than the SMPS off level. If ON5 is connected to REF, the 5V SMPS starts after the 3.3V SMPS reaches regulation (delay start). Drive ON5 below the clear fault level to reset the fault latches.
2	3	ON3	3.3V SMPS Enable Input. The 3.3V SMPS is enabled if ON3 is greater than the SMPS on level and disabled if ON3 is less than the SMPS off level. If ON3 is connected to REF, the 3.3V SMPS starts after the 5V SMPS reaches regulation (delay start). Drive ON3 below the clear fault level to reset the fault latches.
_	4	ONA	LDOA Enable Input. When ONA is low, LDOA is high impedance and the secondary winding control is off. When ONA is high, LDOA is on. Connect to LDO3, LDO5, CSL3, CSL5, or other output for desired automatic startup sequencing.
3	5	FSEL	Frequency-Select Input. This three-level logic input sets the controller's switching frequency. Connect to GND, REF, or V_{CC} to select the following typical switching frequencies: $V_{CC} = 500 \text{kHz}$, REF = 300kHz , GND = 200kHz
4	6	ILIM3	3.3V SMPS Peak Current-Limit Threshold Adjustment. The current-limit threshold defaults to 75mV if ILIM3 is connected to V _{CC} . In adjustable mode, the current-limit threshold across CSH3 and CSL3 is precisely 1/10 the voltage seen at ILIM3 over a 500mV to 2.0V range. The logic threshold for switchover to the 75mV default value is approximately V _{CC} - 1V.
5	7	ILIM5	5V SMPS Peak Current-Limit Threshold. The current-limit threshold defaults to 75mV if ILIM5 is connected to $V_{\rm CC}$. In adjustable mode, the current-limit threshold across CSH5 and CSL5 is precisely 1/10th the voltage seen at ILIM5 over a 500mV to 2.0V range. The logic threshold for switchover to the 75mV default value is approximately $V_{\rm CC}$ - 1V.
6	8	REF	2.0V Reference Voltage Output. Bypass REF to analog ground with a 0.1µF or greater ceramic capacitor. The reference can source up to 100µA for external loads. Loading REF degrades output-voltage accuracy according to the REF load-regulation error. The reference shuts down when \$\overline{SHDN}\$ is low.
7	9	GND	Analog Ground. Connect the backside pad to GND.
8	10	Vcc	Analog Supply Input. Connect to the system supply voltage (+4.5V to +5.5V) through a series 20Ω resistor. Bypass V _{CC} to analog ground with a 1µF or greater ceramic capacitor.
9	11	PGDLY	Power-Good One-Shot Delay. Place a timing capacitor on PGDLY to delay PGOOD going high. PGDLY has a $5\mu\text{A}$ pullup current and a 10Ω pulldown. The pulldown is activated when power is not good. When power is good, the pulldown is shut off and the $5\mu\text{A}$ pullup is activated. When PGDLY crosses REF, PGOOD is enabled.

Pin Description (continued)

PIN						
MAX1533A	MAX1537A	NAME	FUNCTION			
10	12	PGOOD	Open-Drain Power-Good Output. PGOOD is low if either output is more than 10% (typ) below the normal regulation point, during soft-start, and in shutdown. PGOOD is delayed on the rising edge by the PGDLY one-shot timer. PGOOD becomes high impedance when both SMPS outputs are in regulation.			
11	13	ŪVP	Undervoltage Fault-Protection Control. Connect $\overline{\text{UVP}}$ to GND to select the default overvoltage threshold of 70% of nominal. Connect to V _{CC} to disable undervoltage protection and clear the undervoltage fault latch.			
12	14	DH3	High-Side Gate-Driver Output for 3.3V SMPS. DH3 swings from LX3 to BST3.			
13	15	BST3	Boost Flying-Capacitor Connection for 3.3V SMPS. Connect to an external capacitor and diode as shown in Figure 6. An optional resistor in series with BST3 allows the DH3 pullup current to be adjusted.			
14	16	LX3	Inductor Connection for 3.3V SMPS. Connect LX3 to the switched side of the inductor. LX3 serves as the lower supply rail for the DH3 high-side gate driver.			
15	17	OVP	Overvoltage Fault-Protection Control. Connect $\overline{\text{OVP}}$ to GND to select the default overvoltage threshold of +11% above nominal. Connect to V _{CC} to disable overvoltage protection and clear the overvoltage fault latch.			
16	18	CSH3	Positive Current-Sense Input for 3.3V SMPS. Connect to the positive terminal of the current-sense element. Figure 9 describes two different current-sensing options.			
17	19	CSL3	Negative Current-Sense Input for 3.3V SMPS. Connect to the negative terminal of the current-sense element. Figure 9 describes two different current-sensing options. CSL3 also serves as the bootstrap input for LDO3.			
18	20	FB3	Feedback Input for 3.3V SMPS. Connect to GND for fixed 3.3V output. In adjustable mode, FB3 regulates to 1V.			
19	21	LDO3	3.3V Internal Linear-Regulator Output. Bypass with 2.2 μ F (min) (1 μ F/20mA). Provides 100mA (min). Power is taken from LDO5. If CSL3 is greater than 3V, the linear regulator shuts down and LDO3 connects to CSL3 through a 1 Ω switch rated for loads up to 200mA.			
20	22	DL3	Low-Side Gate-Driver Output for 3.3V SMPS. DL3 swings from PGND to LDO5.			
21	23	PGND	Power Ground			
22	24	DL5	Low-Side Gate-Driver Output for 5V SMPS. DL5 swings from PGND to LDO5.			
23	25	LDO5	5V Internal Linear-Regulator Output. Bypass with 2.2 μ F (min) (1 μ F/20mA). Provides power for the DL_ low-side gate drivers, the DH_ high-side drivers through the BST diodes, the PWM controller, logic, and reference through the V _{CC} pin, as well as the LDO3 internal 3.3V linear regulator. Provides 100mA (min) for external loads (+25mA for gate drivers). If CSL5 is greater than 4.5V, the linear regulator shuts down and LDO5 connects to CSL5 through a 0.75 Ω switch rated for loads up to 200mA.			
24	26	FB5	Feedback Input for 5V SMPS. Connect to GND for fixed 5V output. In adjustable mode, FB5 regulates to 1V.			

Pin Description (continued)

PIN					
MAX1533A	MAX1537A	NAME	FUNCTION		
25	27	CSL5	Negative Current-Sense Input for 5V SMPS. Connect to the negative terminal of the current-sense element. Figure 9 describes two different current-sensing options. CSL5 also serves as the bootstrap input for LDO5.		
26	28	CSH5	Positive Current-Sense Input for 5V SMPS. Connect to the positive terminal of the current-sense element. Figure 9 describes two different current-sensing options.		
27	29	IN	Input of the Startup Circuitry and the LDO5 Internal 5V Linear Regulator. Bypass to PGND with 0.22µF close to the IC.		
28	30	LX5	Inductor Connection for 5V SMPS. Connect LX5 to the switched side of the inductor. LX5 serves as the lower supply rail for the DH5 high-side gate driver.		
29	31	BST5	Boost Flying-Capacitor Connection for 5V SMPS. Connect to an external capacitor and diode as shown in Figure 6. An optional resistor in series with BST5 allows the DH5 pullup current to be adjusted.		
30	32	DH5	High-Side Gate-Driver Output for 5V SMPS. DH5 swings from LX5 to BST5.		
31	33	SKIP	Pulse-Skipping Control Input. Connect to V _{CC} for low-noise forced-PWM mode. Connect to GND for high-efficiency pulse-skipping mode at light loads.		
32	34	SHDN	Shutdown Control Input. The device enters its 5µA supply-current shutdown mode if VSHDN is less than the SHDN input falling-edge trip level and does not restart until VSHDN is greater than the SHDN input rising-edge trip level. Connect SHDN to VIN for automatic startup. SHDN can be connected to VIN through a resistive voltage-divider to implement a programmable undervoltage lockout.		
_	35	INA	Supply Voltage Input for the Auxiliary LDOA Linear Regulator. INA is clamped with an internal shunt to 26V.		
_	36	LDOA	Adjustable (12V Nominal) 150mA Auxiliary Linear-Regulator Output. Input supply comes from INA. Bypass LDOA to GND with 2.2µF (min) (1µF/20mA). Secondary feedback threshold is set at INA - LDOA = 0.8V, and triggers the DL5 on the 5V SMPS only. ONA high enables regulator output and secondary regulation. PGOOD is not affected by the state of LDOA.		

Table 1. Component Selection for Standard Applications

COMPONENT	5A/300kHz	5A/500kHz		
Input Voltage	V _{IN} = 7V to 24V	V _{IN} = 7V to 24V		
C _{IN_} , Input Capacitor	(2) 10µF, 25V Taiyo Yuden TMK432BJ106KM	(2) 10µF, 25V Taiyo Yuden TMK432BJ106KM		
C _{OUT5} , Output Capacitor	150μF, 6.3V, 40m Ω , low-ESR capacitor Sanyo 6TPB150ML	150μF, 6.3V, 40mΩ, low-ESR capacitor Sanyo 6TPB150ML		
C _{OUT3} , Output Capacitor	220μF, 4V, 40mΩ, low-ESR capacitor Sanyo 4TPB220ML	220μF, 4V, 40mΩ, low-ESR capacitor Sanyo 4TPB220ML		
N _H _ High-Side MOSFET	Fairchild Semiconductor FDS6612A International Rectifier IRF7807V	Fairchild Semiconductor FDS6612A International Rectifier IRF7807V		
N _{L_} Low-Side MOSFET	Fairchild Semiconductor FDS6670S International Rectifier IRF7807VD1	Fairchild Semiconductor FDS6670S International Rectifier IRF7807VD1		
D _{L_} Schottky Rectifier (if needed)	2A, 30V, 0.45V _f Nihon EC21QS03L	2A, 30V, 0.45V _f Nihon EC21QS03L		
Inductor/Transformer	T1 = 6.8µH, 1:2 turns Sumida 4749-T132 L1 = 5.8µH, 8.6A Sumida CDRH127-5R8NC	3.9µH Sumida CDRH124-3R9NC		
Rcs	10mΩ ±1%, 0.5W resistor IRC LR2010-01-R010F or Dale WSL-2010-R010F	10mΩ ±1%, 0.5W resistor IRC LR2010-01-R010F or Dale WSL-2010-R010F		

Table 2. Component Suppliers

SUPPLIER	WEBSITE		
AVX	www.avx.com		
Central Semiconductor	www.centralsemi.com		
Coilcraft	www.coilcraft.com		
Coiltronics	www.coiltronics.com		
Fairchild Semiconductor	www.fairchildsemi.com		
International Rectifier	www.irf.com		
Kemet	www.kemet.com		

Detailed Description

The MAX1533A/MAX1537A standard application circuit (Figure 1) generates the 5V/5A and 3.3V/5A typical of the main supplies in a notebook computer. The input supply range is 7V to 24V. See Table 1 for component selections and Table 2 for component manufacturers.

The MAX1533A/MAX1537A contain two interleaved fixed-frequency step-down controllers designed for low-voltage power supplies. The optimal interleaved architecture guarantees out-of-phase operation, reducing the input capacitor ripple. Two internal LDOs generate the keep-alive 5V and 3.3V power. The MAX1537A has an auxiliary LDO that can be configured to the preset 12V output or an adjustable output.

SUPPLIER	WEBSITE		
Panasonic	www.panasonic.com/industrial		
Sanyo	www.semiconductor-sanyo.com		
Sumida	www.sumida.com		
Taiyo Yuden	www.t-yuden.com		
TDK	www.component.tdk.com		
TOKO	www.tokoam.com		
Vishay (Dale, Siliconix)	www.vishay.com		

Fixed Linear Regulators (LDO5 and LDO3)

Two internal linear regulators produce preset 5V (LDO5) and 3.3V (LDO3) low-power outputs. LDO5 powers LDO3, the gate drivers for the external MOSFETs, and provides the bias supply (VCC) required for the SMPS analog control, reference, and logic blocks. LDO5 supplies at least 100mA for external and internal loads, including the MOSFET gate drive, which typically varies from 5mA to 50mA, depending on the switching frequency and external MOSFETs selected. LDO3 also supplies at least 100mA for external loads. Bypass LDO5 and LDO3 with a 2.2µF or greater output capacitor, using an additional 1.0µF per 20mA of internal and external load.

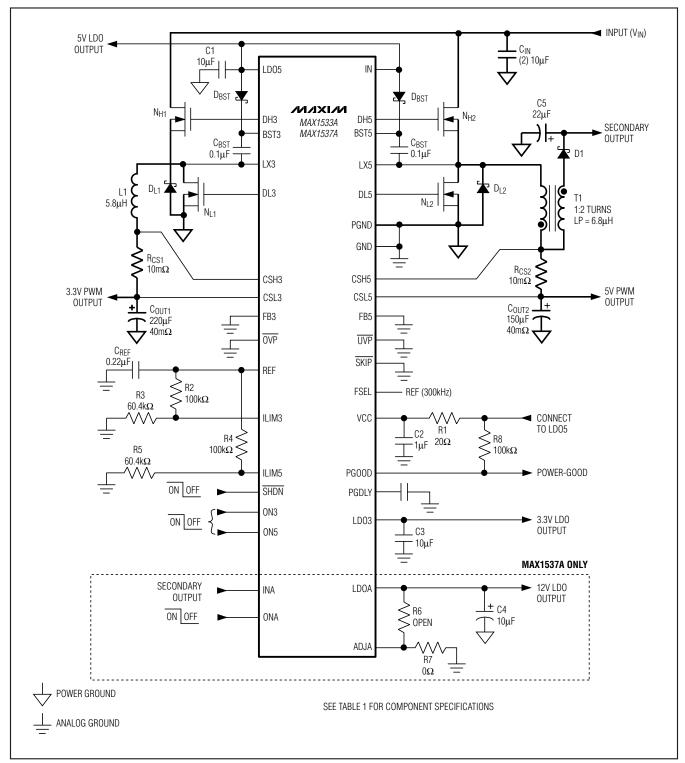


Figure 1. MAX1533A/MAX1537A Standard Application Circuit

SMPS to LDO Bootstrap Switchover

When the 5V main output voltage is above the LDO5 bootstrap-switchover threshold, an internal 0.75Ω (typ) p-channel MOSFET shorts CSL5 to LDO5 while simultaneously shutting down the LDO5 linear regulator. Similarly, when the 3.3V main output voltage is above the LDO3 bootstrap-switchover threshold, an internal 1Ω (typ) p-channel MOSFET shorts CSL3 to LDO3 while simultaneously shutting down the LDO3 linear regulator. These actions bootstrap the device, powering the internal circuitry and external loads from the output SMPS voltages, rather than through linear regulators from the battery. Bootstrapping reduces power dissipation due to gate charge and guiescent losses by providing power from a 90%-efficient switch-mode source, rather than from a much-less-efficient linear regulator. The output current limit increases to 200mA when the LDO_ outputs are switched over.

SMPS 5V Bias Supply (LDO5 and Vcc)

The A switch-mode power supplies (SMPS) require a 5V bias supply in addition to the high-power input supply (battery or AC adapter). This 5V bias supply is generated by the MAX1533A/MAX1537As' internal 5V linear regulator (LDO5). This bootstrapped LDO allows the MAX1533A/MAX1537A to power-up independently. The gate-driver input supply is connected to the fixed 5V linear-regulator output (LDO5). Therefore, the 5V LDO supply must provide $V_{\rm CC}$ (PWM controller) and the gate-drive power, so the maximum supply current required is:

 $I_{BIAS} = I_{CC} + f_{SW} (Q_{G(LOW)} + Q_{G(HIGH)})$ = 5mA to 50mA (typ)

where I_{CC} is 1mA (typ), f_{SW} is the switching frequency, and $Q_{G(LOW)}$ and $Q_{G(HIGH)}$ are the MOSFET data sheet's total gate-charge specification limits at $V_{GS} = 5V$.

Reference (REF)

The 2V reference is accurate to $\pm 1\%$ over temperature and load, making REF useful as a precision system reference. Bypass REF to GND with a $0.22\mu F$ or greater ceramic capacitor. The reference sources up to $100\mu A$ and sinks $10\mu A$ to support external loads. If highly accurate specifications ($\pm 0.5\%$) are required for the main SMPS output voltages, the reference should not be loaded. Loading the reference reduces the LDO5, LDO3, OUT5, and OUT3 output voltages slightly because of the reference load-regulation error.

System Enable/Shutdown (SHDN)

Drive SHDN below the precise SHDN input falling-edge trip level to place the MAX1533A/MAX1537A in their low-power shutdown state. The MAX1533A/MAX1537A consume only 5µA of quiescent current while in shutdown mode. When shutdown mode activates, the reference turns off, making the threshold to exit shutdown less accurate. To guarantee startup, drive SHDN above 2.2V (SHDN input rising-edge trip level). For automatic shutdown and startup, connect SHDN to VIN. The accurate 1V falling-edge threshold on SHDN can be used to detect a specific input-voltage level and shut the device down. Once in shutdown, the 1.6V rising-edge threshold activates, providing sufficient hysteresis for most applications.

SMPS Detailed ____Description

SMPS POR, UVLO, and Soft-Start

Power-on reset (POR) occurs when V_{CC} rises above approximately 1V, resetting the undervoltage, overvoltage, and thermal-shutdown fault latches. The POR circuit also ensures that the low-side drivers are pulled low if OVP is disabled $(\overline{OVP} = V_{CC})$, or driven high if OVP is enabled $(\overline{OVP} = GND)$ until the SMPS controllers are activated.

The V_{CC} input undervoltage-lockout (UVLO) circuitry inhibits switching if the 5V bias supply (LDO5) is below the 4V input UVLO threshold. Once the 5V bias supply (LDO5) rises above this input UVLO threshold and the controllers are enabled, the SMPS controllers start switching and the output voltages begin to ramp up using soft-start.

The internal digital soft-start gradually increases the internal current-limit level during startup to reduce the input surge currents. The MAX1533A/MAX1537A divide the soft-start period into five phases. During the first phase, each controller limits its current limit to only 20% of its full current limit. If the output does not reach regulation within 128 clock cycles (1/fosc), soft-start enters the second phase and the current limit is increased by another 20%. This process repeats until the maximum current limit is reached after 512 clock cycles (1/fosc) or when the output reaches the nominal regulation voltage, whichever occurs first (see the startup waveforms in the *Typical Operating Characteristics*).

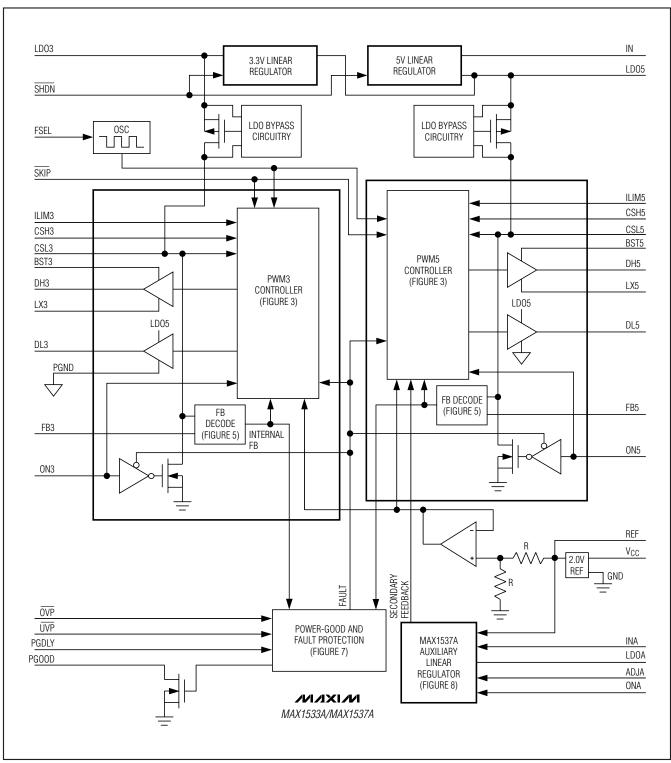


Figure 2. MAX1533A/MAX1537A Functional Diagram

Table 3. Operating Modes

MODE	INPUTS*			OUTPUTS			
MODE	SHDN	ON5	ON3	LDO5	LDO3	5V SMPS	3V SMPS
Shutdown Mode	LOW	Х	Χ	OFF	OFF	OFF	OFF
Standby Mode	HIGH	LOW	LOW	ON	ON	OFF	OFF
Normal Operation	HIGH	HIGH	HIGH	ON	ON	ON	ON
3.3V SMPS Active	HIGH	LOW	HIGH	ON	ON	OFF	ON
5V SMPS Active	HIGH	HIGH	LOW	ON	ON	ON	OFF
Normal Operation (Delayed 5V SMPS Startup)	HIGH	REF	HIGH	ON	ON	ON Power-up after 3.3V SMPS is in regulation	ON
Normal Operation (Delayed 3.3V SMPS Startup)	HIGH	HIGH	REF	ON	ON	ON	ON Power-up after 5V SMPS is in regulation

^{*}SHDN is an accurate, low-voltage logic input with 1V falling-edge threshold voltage and 1.6V rising-edge threshold voltage. ON3 and ON5 are 3-level CMOS logic inputs, a logic-low voltage is less than 0.8V, a logic-high voltage is greater than 2.4V, and the middle logic level is between 1.9V and 2.1V (see the Electrical Characteristics table).

SMPS Enable Controls (ON3, ON5)

ON3 and ON5 control SMPS power-up sequencing. ON3 or ON5 rising above 2.4V enables the respective outputs. ON3 or ON5 falling below 1.6V disables the respective outputs. Driving ON_ below 0.8V clears the overvoltage, undervoltage, and thermal fault latches.

SMPS Power-Up Sequencing

Connecting ON3 or ON5 to REF forces the respective outputs off while the other output is below regulation and starts after that output regulates. The second SMPS remains on until the first SMPS turns off, the device shuts down, a fault occurs, or LDO5 goes into undervoltage lockout. Both supplies begin their power-down sequence immediately when the first supply turns off.

Output Discharge (Soft-Shutdown)

When output discharge is enabled ($\overline{\text{OVP}}$ pulled low) and the switching regulators are disabled—by transitions into standby or shutdown mode, or when an output undervoltage fault occurs—the controller discharges both outputs through internal 12Ω switches, until the output voltages decrease to 0.3V. This slowly discharges the output capacitance, providing a soft-damped shutdown response. This eliminates the slightly negative output voltages caused by quickly discharging the output through the inductor and low-side MOSFET. When an SMPS output discharges to

0.3V, its low-side driver (DL_) is forced high, clamping the respective SMPS output to GND. The reference remains active to provide an accurate threshold and to provide overvoltage protection. Both SMPS controllers contain separate soft-shutdown circuits.

When output discharge is disabled ($\overline{OVP} = V_{CC}$), the low-side drivers (DL_) and high-side drivers (DH_) are both pulled low, forcing LX into a high-impedance state. Since the outputs are not actively discharged by the SMPS controllers, the output-voltage discharge rate is determined only by the output capacitance and load current.

Fixed-Frequency, Current-Mode PWM Controller

The heart of each current-mode PWM controller is a multi-input, open-loop comparator that sums two signals: the output-voltage error signal with respect to the reference voltage and the slope-compensation ramp (Figure 3). The MAX1533A/MAX1537A use a direct-summing configuration, approaching ideal cycle-to-cycle control over the output voltage without a traditional error amplifier and the phase shift associated with it. The MAX1533A/MAX1537A use a relatively low loop gain, allowing the use of low-cost output capacitors. The low loop gain results in the -0.1% typical load-regulation error and helps reduce the output capacitor size and cost by shifting the unity-gain crossover frequency to a lower level.

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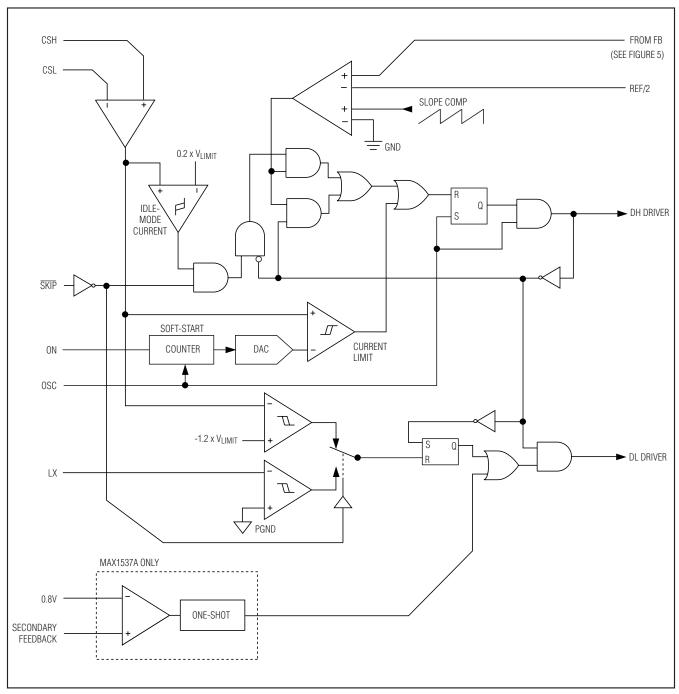


Figure 3: PWM-Controller Functional Diagram

Frequency Selection (FSEL)

The FSEL input selects the PWM-mode switching frequency. Table 4 shows the switching frequency based on FSEL connection. High-frequency (500kHz) operation optimizes the application for the smallest component size, trading off efficiency due to higher switching losses. This may be acceptable in ultra-portable devices where the load currents are lower. Low-frequency (200kHz) operation offers the best overall efficiency at the expense of component size and board space.

Forced-PWM Mode

The low-noise forced-PWM mode disables the zero-crossing comparator, which controls the low-side switch on-time. This forces the low-side gate-drive waveform to constantly be the complement of the high-side gate-drive waveform, so the inductor current reverses at light loads while DH_ maintains a duty factor of VOUT/VIN. The benefit of forced-PWM mode is to keep the switching frequency fairly constant. However, forced-PWM operation comes at a cost: the no-load 5V supply current remains between 15mA and 50mA, depending on the external MOSFETs and switching frequency.

Forced-PWM mode is most useful for avoiding audiofrequency noise and improving load-transient response. Since forced-PWM operation disables the zero-crossing comparator, the inductor current reverses under light loads.

Light-Load Operation Control (SKIP)

The MAX1533A/MAX1537A include a light-load operating-mode control input (SKIP) used to independently enable or disable the zero-crossing comparator for both controllers. When the zero-crossing comparator is enabled, the controller forces DL_ low when the current-sense inputs detect zero inductor current. This keeps the inductor from discharging the output capacitors and forces the controller to skip pulses under light-load conditions to avoid overcharging the output. When the zero-crossing comparator is disabled, the controller is forced to maintain PWM operation under light-load conditions (forced-PWM).

Table 4. FSEL Configuration Table

FSEL	SWITCHING FREQUENCY
Vcc	500kHz
REF	300kHz
GND	200kHz

Idle-Mode Current-Sense Threshold

The on-time of the step-down controller terminates when the output voltage exceeds the feedback threshold and when the current-sense voltage exceeds the idle-mode current-sense threshold. Under light-load conditions, the on-time duration depends solely on the idle-mode current-sense threshold, which is approximately 20% of the full-load current-limit threshold set by ILIM_. This forces the controller to source a minimum amount of power with each cycle. To avoid overcharging the output, another on-time cannot begin until the output voltage drops below the feedback threshold. Since the zero-crossing comparator prevents the switching regulator from sinking current, the controller must skip pulses. Therefore, the controller regulates the valley of the output ripple under light-load conditions.

Automatic Pulse-Skipping Crossover

In skip mode, an inherent automatic switchover to PFM takes place at light loads (Figure 4). This switchover is affected by a comparator that truncates the low-side switch on-time at the inductor current's zero crossing. The zero-crossing comparator senses the inductor current across the low-side MOSFET (PGND to LX_). Once VPGND - VLX_ drops below the 3mV zero-crossing current-sense threshold, the comparator forces DL_ low (Figure 3). This mechanism causes the threshold between pulse-skipping PFM and nonskipping PWM operation to coincide with the boundary between continuous and discontinuous inductor-current operation (also known as the "critical conduction" point). The load-current level at which PFM/PWM crossover occurs, ILOAD(SKIP), is given by:

$$I_{LOAD(SKIP)} = \frac{V_{OUT} (V_{IN} - V_{OUT})}{2 \times V_{IN} \times f_{SW} \times L}$$

The switching waveforms may appear noisy and asynchronous when light loading causes pulse-skipping operation, but this is a normal operating condition that results in high light-load efficiency. Trade-offs in PFM noise vs. light-load efficiency are made by varying the inductor value. Generally, low inductor values produce a broader efficiency vs. load curve, while higher values result in higher full-load efficiency (assuming that the coil resistance remains fixed) and less output voltage ripple. Penalties for using higher inductor values include larger physical size and degraded load-transient response (especially at low input-voltage levels).

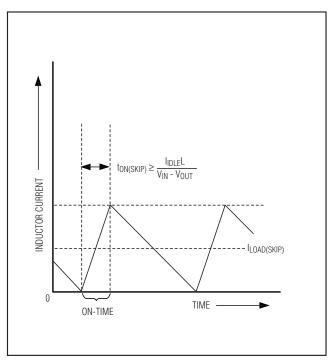


Figure 4. Pulse-Skipping/Discontinuous Crossover Point

Output Voltage

DC output accuracy specifications in the *Electrical Characteristics* table refer to the error-comparator's threshold. When the inductor continuously conducts, the MAX1533A/MAX1537A regulate the peak of the output ripple, so the actual DC output voltage is lower than the slope-compensated trip level by 50% of the output ripple voltage. For PWM operation (continuous conduction), the output voltage is accurately defined by the following equation:

$$V_{OUT(PWM)} = V_{NOM} \left(1 - \frac{A_{SLOPE}V_{NOM}}{V_{IN}}\right) - \left(\frac{V_{RIPPLE}}{2}\right)$$

where V_{NOM} is the nominal output voltage, ASLOPE equals 1%, and V_{RIPPLE} is the output ripple voltage ($V_{RIPPLE} = ESR \times \Delta I_{INDUCTOR}$ as described in the Output Capacitor Selection section).

In discontinuous conduction (I_{OUT} < I_{LOAD(SKIP)}), the MAX1533A/MAX1537A regulate the valley of the output ripple, so the output voltage has a DC regulation level higher than the error-comparator threshold. For PFM operation (discontinuous conduction), the output voltage is approximately defined by the following equation:

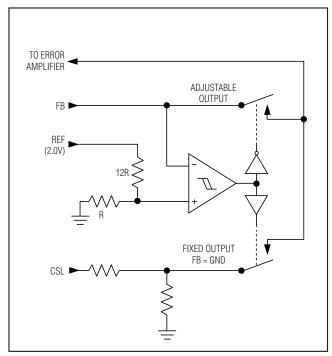


Figure 5. Dual-Mode Feedback Decoder

$$V_{OUT(PFM)} = V_{NOM} + \frac{1}{2} \left(\frac{f_{SW}}{f_{OSC}} \right) I_{IDLE} \times ESR$$

where V_{NOM} is the nominal output voltage, fosc is the maximum switching frequency set by the internal oscillator, fsw is the actual switching frequency, and I_{IDLE} is the idle-mode inductor current when pulse skipping.

Adjustable/Fixed Output Voltages (Dual-Mode Feedback)

Connect FB3 and FB5 to GND to enable the fixed SMPS output voltages (3.3V and 5V, respectively), set by a preset, internal resistive voltage-divider connected between CSL_ and analog ground. Connect a resistive voltage-divider at FB_ between CSL_ and GND to adjust the respective output voltage between 1V and 5.5V (Figure 5). Choose R2 (resistance from FB to GND) to be about $10 k\Omega$ and solve for R1 (resistance from OUT to FB) using the equation:

$$R1 = R2 \left(\frac{V_{OUT}}{V_{FB}} - 1 \right)$$

where $V_{FB} = 1V$ nominal.

When adjusting both output voltages, set the 3.3V SMPS lower than the 5V SMPS. LDO5 connects to the 5V output (CSL5) through an internal switch only when CSL5 is above the LDO5 bootstrap threshold (4.56V). Similarly, LDO3 connects to the 3.3V output (CSL3) through an internal switch only when CSL3 is above the LDO3 bootstrap threshold (2.91V). Bootstrapping works most effectively when the fixed output voltages are used. Once LDO_ is bootstrapped from CSL_, the internal linear regulator turns off. This reduces internal power dissipation and improves efficiency at higher input voltage.

Current-Limit Protection (ILIM_)

The current-limit circuit uses differential current-sense inputs (CSH_ and CSL_) to limit the peak inductor current. If the magnitude of the current-sense signal exceeds the current-limit threshold, the PWM controller turns off the high-side MOSFET (Figure 3). At the next rising edge of the internal oscillator, the PWM controller does not initiate a new cycle unless the current-sense signal drops below the current-limit threshold. The actual maximum load current is less than the peak current-limit threshold by an amount equal to half of the inductor ripple current. Therefore, the maximum load capability is a function of the current-sense resistance, inductor value, switching frequency, and duty cycle (VOUT/VIN).

In forced-PWM mode, the MAX1533A/MAX1537A also implement a negative current limit to prevent excessive reverse inductor currents when V_{OUT} is sinking current. The negative current-limit threshold is set to approximately 120% of the positive current limit and tracks the positive current limit when ILIM_ is adjusted.

Connect ILIM_ to VCC for the 75mV default threshold, or adjust the current-limit threshold with an external resistor-divider at ILIM_. Use a 2 μ A to 20 μ A divider current for accuracy and noise immunity. The current-limit threshold adjustment range is from 50mV to 200mV. In the adjustable mode, the current-limit threshold voltage equals precisely 1/10th the voltage seen at ILIM_. The logic threshold for switchover to the 75mV default value is approximately VCC - 1V.

Carefully observe the PC board layout guidelines to ensure that noise and DC errors do not corrupt the differential current-sense signals seen by CSH_ and CSL_. Place the IC close to the sense resistor with short, direct traces, making a Kelvin-sense connection to the current-sense resistor.

MOSFET Gate Drivers (DH_, DL_)

The DH_ and DL_ drivers are optimized for driving moderate-sized high-side and larger low-side power MOSFETs. This is consistent with the low duty factor seen in notebook applications, where a large V_{IN} - V_{OUT} differential exists. The high-side gate drivers (DH_) source and sink 2A, and the low-side gate drivers (DL_) source 1.7A and sink 3.3A. This ensures robust gate drive for high-current applications. The DH_ floating high-side MOSFET drivers are powered by diode-capacitor charge pumps at BST_ (Figure 6) while the DL_ synchronous-rectifier drivers are powered directly by the fixed 5V linear regulator (LDO5).

Adaptive dead-time circuits monitor the DL_ and DH_ drivers and prevent either FET from turning on until the other is fully off. The adaptive driver dead time allows operation without shoot-through with a wide range of MOSFETs, minimizing delays and maintaining efficiency. There must be a low-resistance, low-inductance path from the DL_ and DH_ drivers to the MOSFET gates for the adaptive dead-time circuits to work properly; otherwise, the sense circuitry in the MAX1533A/ MAX1537A interprets the MOSFET gates as "off" while charge actually remains. Use very short, wide traces (50 to 100 mils wide if the MOSFET is 1 inch from the driver).

The internal pulldown transistor that drives DL_ low is robust, with a 0.6Ω (typ) on-resistance. This helps prevent DL_ from being pulled up due to capacitive coupling from the drain to the gate of the low-side MOSFETs when the inductor node (LX_) quickly switches from ground to VIN. Applications with high input voltages and long inductive driver traces may require additional gate-to-source capacitance to ensure fastrising LX_ edges do not pull up the low-side MOSFETs' gate, causing shoot-through currents. The capacitive coupling between LX_ and DL_ created by the MOSFET's gate-to-drain capacitance (CRSS), gate-to-source capacitance (CISS - CRSS), and additional board parasitics should not exceed the following minimum threshold:

$$V_{GS(TH)} > V_{IN} \left(\frac{C_{RSS}}{C_{ISS}} \right)$$

Lot-to-lot variation of the threshold voltage may cause problems in marginal designs. Alternatively, adding a resistor less than 10Ω in series with BST_ may remedy the problem by increasing the turn-on time of the high-side MOSFET without degrading the turn-off time (Figure 6).

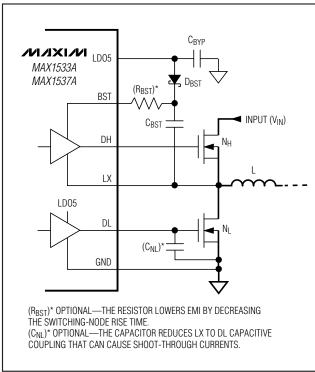


Figure 6. Optional Gate-Driver Circuitry

Power-Good Output (PGOOD)

PGOOD is the open-drain output of a comparator that continuously monitors both SMPS output voltages for undervoltage conditions. PGOOD is actively held low in shutdown (SHDN or ON3 or ON5 = GND), soft-start, and soft-shutdown. Once the digital soft-start terminates, PGOOD becomes high impedance as long as both outputs are above 90% of the nominal regulation voltage set by FB_. PGOOD goes low once either SMPS output drops 10% below its nominal regulation point, an output overvoltage fault occurs, or either SMPS controller is shut down. For a logic-level PGOOD output voltage, connect an external pullup resistor between PGOOD and $V_{\rm CC}$. A $100{\rm k}\Omega$ pullup resistor works well in most applications.

 $\underline{\mathsf{PGOOD}}$ is independent of the fault protection states $\overline{\mathsf{OVP}}$ and $\overline{\mathsf{UVP}}.$

Fault Protection

Output Overvoltage Protection (OVP)

If the output voltage of either SMPS rises above 111% of its nominal regulation voltage and the OVP protection is enabled (OVP = GND), the controller sets the fault latch, pulls PGOOD low, shuts down both SMPS controllers, and immediately pulls DH_ low and forces DL_

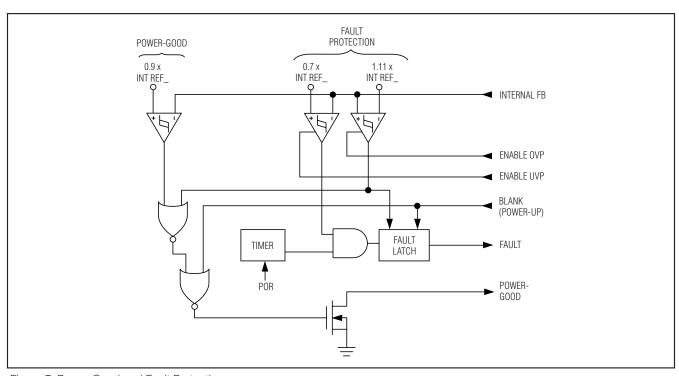


Figure 7. Power-Good and Fault Protection